

	TECH	INICAL DATA SH	IEET	2 / 7	
BOAR	RD TO BOARD AI	4M	R107.064.070		
REEL OF 100				Series : IMP	
PACKAGING Standard Unit Other 100 'W' option Contact us		SPECIFICATION			
ELECTRICAL CHARACTERISTICS			<u>ENVIRONMENTAL</u>		
Impedance Frequency VSWR Insertion loss RF leakage Voltage rating	0-6 1.5 + 0,0000 0.3 - (NA	Ω GHz x F(GHz) Maxi √F(GHz) dB Maxi - F(GHz)) dB Maxi Veff Maxi	Operating temper Hermetic seal Panel leakage	rature -40/+90 ° C NA Atm.cm3/s NA	
Voltage100Volt MathDielectric withstanding voltage 350 Veff miniInsulation resistance 3000 M Ω mini			OTHERS CHARACTERISTICS		
			Assembly instruc Others :	ction	
MECHAN	ICAL CHARACTE	<u>RISTICS</u>			
Center contact retenti Axial force – Matin Axial force – Oppos Torque	g end NA site end NA	N mini N mini N.cm mini			
Recommended torque Mating Panel nut	NA	N.cm N.cm			
Mating life Weight	10 0,0130	Cycles mini g			
Issue : 1343 C In the effort to improve necessary.	our products, we reserve	the right to make cha	anges judged to be		

TECHNICAL DATA SHEET

BOARD TO BOARD ADAPTOR H=2MM

REEL OF 100

Series : IMP

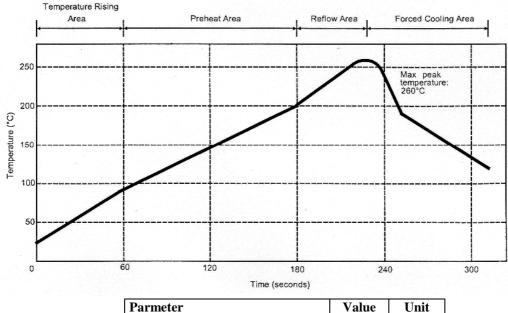
R107.064.070

SOLDER PROCEDURE

1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.

We advise a thickness of 150 microns (5.850 microinch). Verify that the edges of the zone are clean.

- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven. Below please find, the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.



TEMPERATURE PROFILE

Parmeter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec



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